

# Zynq UltraScale+ RFSoc

- > Integrated RF-Class Analog and Error Correction Technology
- > Delivering 50-75% Power & Footprint Reduction
- > Full Programmability across the RF Signal Chain

## OVERVIEW

Zynq® UltraScale+™ RFSocs integrate gigasample RF data converters and soft-decision forward error correction (SD-FEC) into an SoC architecture. The Zynq UltraScale+ RFSoc family simplifies system design with fewer components and provides platform hardware and software flexibility.

The portfolio features a breadth of devices with varying direct RF performance to meet diverse spectrum needs and use cases.

## HIGHLIGHTS

### Industry's Only Adaptable Single-Chip Radio Platform

- > Integrated direct RF-sampling moves RF design to the digital domain
- > User configurable SD-FEC integrated cores
- > Programmable logic for diverse requirements and emerging standards
- > Multicore heterogeneous Arm®-based processing system
- > Built on production-proven UltraScale™ architecture

### Cost Effective and Power Efficient Devices

- > Lower power by eliminating JESD204 interfaces
- > Over 50% PCB area reduction vs. discrete solutions
- > 80% more power efficient SD-FEC vs. a soft implementation

### Future-Proof Comprehensive Solution

- > Fulfilling 3G, 4G, and multiband 5G requirements
- > Wide bandwidth for sub-6GHz and mmWave radio applications
- > Fully integrated Remote-PHY solution for DOCSIS 3.1 standards
- > L-Band, S-Band, and C-Band direct sampling



## TARGET APPLICATIONS

- > 4G and 5G Remote Wireless Infrastructure
- > Remote Radio for Massive MIMO
- > Fixed Wireless Access
- > 5G Baseband
- > Mobile Backhaul
- > Phased Array Radar
- > Remote-PHY for Cable Access DOCSIS 3.1
- > Test and Measurement
- > Satellite Communications
- > Automotive LiDAR

## FEATURES

|                                    | GEN 1   | GEN 2         | GEN 3                     |
|------------------------------------|---|---------------|---------------------------|
| <b>RF DATA CONVERTER SUBSYSTEM</b> |   |               |                           |
| Maximum RF Input Frequency         | 4GHz  | 5GHz          | 6GHz                      |
| 12-bit RF-ADCs                     | 16x 2.058GSPS<br>8x 4.096GSPS   | 16x 2.275GSPS | -                         |
| 14-bit RF-ADCs                     | -   | -             | 8x 5.0GSPS<br>16x 2.5GSPS |
| 14-bit RF-DACs                     | 16x 6.554GSPS   | 16x 6.554GSPS | 16x 10.0GSPS              |
| User Configurable SD-FEC Blocks    | 8   | 0             | 8                         |
| LDPC Encode Throughput             | 19.8Gb/s  | -             | 19.8Gb/s                  |
| LDPC Decode Throughput             | 2.84Gb/s @8 iterations  | -             | 2.84Gb/s @8 iterations    |
| Turbo Decode Throughput            | 1.78Gb/s @6 iterations  | -             | 1.78Gb/s @6 iterations    |
| <b>PROGRAMMABLE LOGIC</b>          |   |               |                           |
| System Logic Cells (K)             | 930   | 930           | 930                       |
| DSP Slices                         | 4,272   | 4,272         | 4,272                     |
| 33G GTY Transceivers               | 16  | 16            | 16                        |
| Memory (Mb)                        | 60.5  | 60.5          | 60.5                      |
| PCIe® Gen 3x16                     | 2   | 2             | -                         |
| PCIe Gen3 x16/Gen4 x8/CCIX         | -   | -             | 2                         |
| 100G Ethernet Blocks with RS-FEC   | 2   | 2             | 2                         |
| 150G Interlaken                    | 1   | 1             | 1                         |
| <b>PROCESSING SYSTEM</b>           |   |               |                           |
| Application Processor Core         | Quad-core Arm Cortex®-A53 MPCore up to 1.33GHz  |               |                           |
| Real-Time Processor Core           | Dual-core Arm Cortex-R5 MPCore up to 533MHz   |               |                           |
| Embedded and External Memory       | 256KB On-Chip Memory w/ECC; External DDR4/3/3L; LPDDR4/3; External Quad-SPI; NAND; eMMC |               |                           |

Note: All numbers are maximum capabilities

## TAKE THE NEXT STEP

Zynq UltraScale+ RFSocCs are supported by comprehensive developments tools, reference designs, an IP catalog, and evaluation platforms.

For more information about Xilinx Zynq UltraScale+ RFSocCs, go to [www.xilinx.com/rfsoc](http://www.xilinx.com/rfsoc). Evaluation kits can be ordered separately.

Visit [Zynq UltraScale+ RFSoc Boards, Kits, and Modules](#) for details and to place an order today.

## Corporate Headquarters

Xilinx, Inc.  
2100 Logic Drive  
San Jose, CA 95124  
USA  
Tel: 408-559-7778  
[www.xilinx.com](http://www.xilinx.com)

## Xilinx Europe

One Logic Drive  
Citywest Business Campus  
Saggart, County Dublin  
Ireland  
Tel: +353-1-464-0311  
[www.xilinx.com](http://www.xilinx.com)

## Japan

Xilinx K.K.  
Art Village Osaki Central Tower 4F  
1-2-2 Osaki, Shinagawa-ku  
Tokyo 141-0032 Japan  
Tel: +81-3-6744-7777  
[japan.xilinx.com](http://japan.xilinx.com)

## Asia Pacific Pte. Ltd.

Xilinx, Asia Pacific  
5 Changi Business Park  
Singapore 486040  
Tel: +65-6407-3000  
[www.xilinx.com](http://www.xilinx.com)

## India

Meenakshi Tech Park  
Block A, B, C, 8th & 13th floors,  
Meenakshi Tech Park, Survey No. 39  
Gachibowli(V), Seri Lingampally (M),  
Hyderabad -500 084  
Tel: +91-40-6721-4747  
[www.xilinx.com](http://www.xilinx.com)

